

N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)		
100	$0.084 \text{ at V}_{GS} = 10 \text{ V}$	6		
	0.095 at V _{GS} = 4.5 V	4.5		

FEATURES

- DT-Trench Power MOSFET
- $\bullet \quad 100\% \; R_g \; and \; UIS \; Tested$



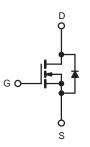
RoHS

APPLICATIONS

- Synchronus Rectification in DC/DC and AC/DC Converters
- Industrial and Motor Drive applications



SOT-223



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_A = 25$ °C, unles	ss otherwise n	noted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	100		V
Gate-Source Voltage		V_{GS}	± 20		
Continuous Drain Current (T _J = 175 °C) ^a	$T_A = 25 ^{\circ}C$	I _D	6.0	4.0	А
	T _A = 70 °C		3.6	3.1	
Pulsed Drain Current		I _{DM}	24		A
Avalanche Current		I _{AS}	18		
Single Pulse Avalanche Energy		E _{AS}	21		mJ
Maximum Power Dissipation ^a	T _A = 25 °C	P _D	4.0	1.9	W
	T _A = 70 °C	٠ ٥	2.6	1.5	VV
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Mariana landing to Ambient 3	t ≤ 10 s	- R _{thJA}	36	45	°C/W
Maximum Junction-to-Ambient ^a	Steady State		75	90	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	17	20	

Notes

a. Surface Mounted on 1" x 1" FR4 board.



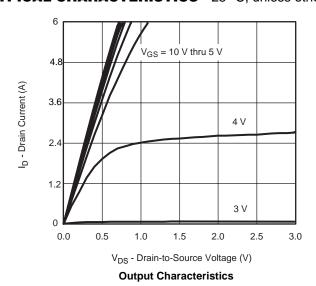
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1		3		
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zana Cata Valtana Duain Course	I _{DSS}	$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}$	1 20		1	μΑ	
Zero Gate Voltage Drain Current		$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			20		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 3.0 \text{ A}$		0.084	0.093	Ω	
		$V_{GS} = 10 \text{ V}, I_D = 2.5 \text{ A}, T_J = 125 \text{ °C}$		0.090	0.096		
Drain-Source On-State Resistance ^a		$V_{GS} = 10 \text{ V}, I_D = 2.0 \text{ A}, T_J = 175 ^{\circ}\text{C}$		0.105	0.120		
		$V_{GS} = 4.5 \text{ V}, I_D = 2.0 \text{ A}$		0.095	0.110		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 80 \text{ V}, I_{D} = 3.0 \text{ A}$		17		S	
Diode Forward Voltage ^a	V_{SD}	I _S = 2.0 A, V _{GS} = 0 V		0.8	1.2	V	
Dynamic ^b			•				
Total Gate Charge	Q_g			18			
Gate-Source Charge	Q_{gs}	$V_{DS} = 80 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 3.0 \text{ A}$		5.4		nC	
Gate-Drain Charge	Q_{gd}			2.3			
Gate Resistance	R_g	V _{GS} = 0.1 V, f = 5 MHz		2.4		Ω	
Turn-On Delay Time	t _{d(on)}			7			
Rise Time	t _r	V_{DD} = 80 V, R_L = 30 Ω		4			
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 3 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		25		ns	
Fall Time	t _f	•		5			
Source-Drain Reverse Recovery Time	t _{rr}	$I_{\rm F} = 1.5 \text{ A}, dI/dt = 100 A/\mu s$		40			

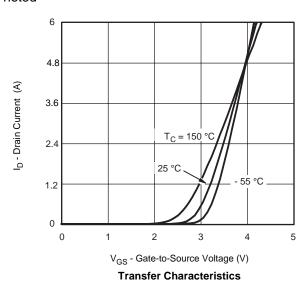
Notes:

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

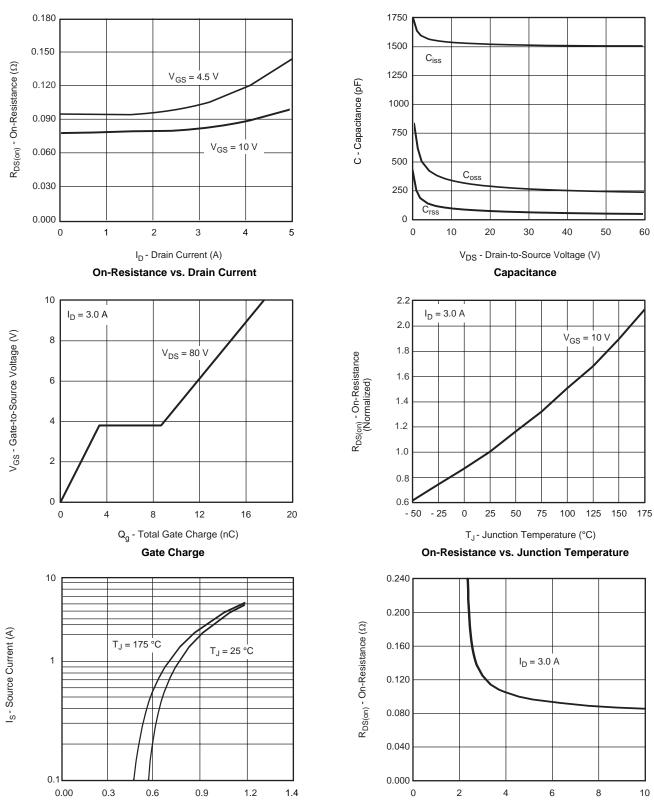






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 V_{SD} - Source-to-Drain Voltage (V) Source-Drain Diode Forward Voltage

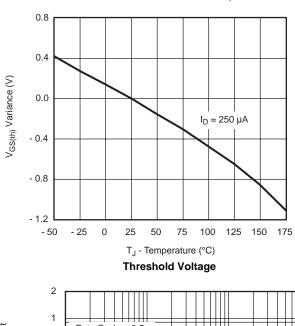


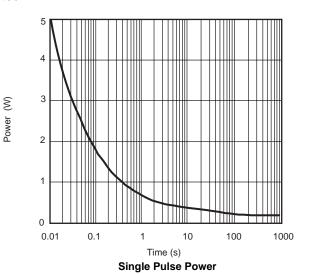
V_{GS} - Gate-to-Source Voltage (V)

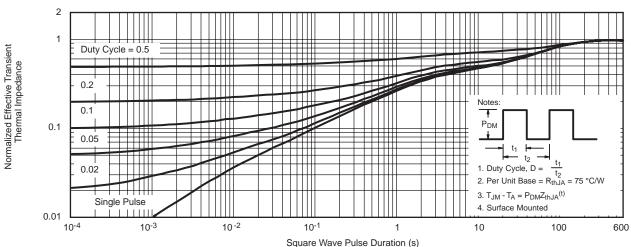
On-Resistance vs. Gate-to-Source Voltage

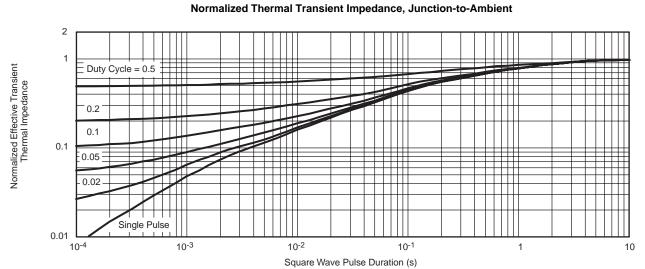


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted









Normalized Thermal Transient Impedance, Junction-to-Foot





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